

支持复位的 TCA9548A-Q1 汽车 8 通道 I²C 开关

1 特性

- AEC-Q100 (等级 1) : 符合汽车应用要求
- 提供功能安全
 - 可帮助进行功能安全系统设计的文档
- 1 至 8 个双向转换开关
- 与 I²C 总线和 SMBus 兼容
- 低电平有效复位输入
- 三个地址引脚, I²C 总线最多支持八个 TCA9548A-Q1 器件
- 通过 I²C 总线进行通道选择, 可任意组合
- 加电时所有开关通道取消选定
- 低 R_{ON} 开关
- 支持在 1.8V、2.5V、3.3V 和 5V 总线间进行电压电平转换
- 加电时无干扰
- 支持热插入
- 低静态电流
- 工作电源电压范围为 1.65V 至 5.25V
- 5V 耐压输入
- 0 至 400kHz 时钟频率
- 闩锁性能超过 100mA, 符合 JESD 78 II 类规范

2 应用

- 信息娱乐系统
- 车身和控制
- 路由器 (电信交换设备)
- 工厂自动化
- 具有 I²C 目标地址冲突 (例如, 多个完全一样的温度传感器) 的产品

3 说明

TCA9548A-Q1 器件配有八个可通过 I²C 总线控制的双向转换开关。SCL/SDA 上行对扩展到八个下行对, 或者通道。根据可编程控制寄存器的内容, 可选择任一单独 SCn/SDn 通道或者通道组合。这些下游通道可用于解决 I²C 目标地址冲突。例如, 如果应用中需要八个完全相同的数字温度传感器, 则每个通道 (0-7) 可以连接一个传感器。

发生超时或其他不当操作时, 系统控制器可通过将 **RESET** 输入置为低电平来复位 TCA9548A-Q1。同样, 上电复位即可取消选中所有通道并初始化 I²C/SMBus 状态机。将 **RESET** 置为有效也可实现复位和初始化, 并且无需将部件断电。这样可以在下游 I²C 总线之一卡在低电平状态时进行恢复。

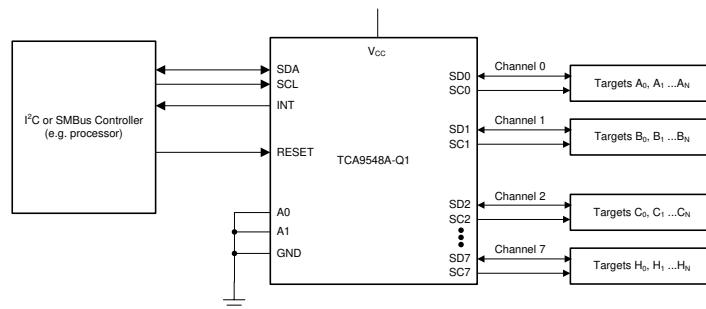
由于在开关上有导通栅极, 因此可使用 VCC 引脚来限制 TCA9548A-Q1 传递的最大高电压。限制最大高电压后, 可以在每个对上使用不同的总线电压, 从而让 1.8V、2.5V 或 3.3V 器件能够在没有任何额外保护的情况下与 5V 器件通信。对于每个通道, 外部上拉电阻器将总线电压上拉至所需的电压水平。所有 I/O 引脚可耐受 5 V 电压。

封装信息

| 器件型号 | 封装 ⁽¹⁾ | 封装尺寸 ⁽²⁾ |
|-------------|-----------------------|---------------------|
| TCA9548A-Q1 | 超薄四方扁平无引线 (VQFN) (24) | 4mm x 4mm |

(1) 如需了解所有可用封装, 请参阅数据表末尾的可订购产品附录。

(2) 封装尺寸 (长 × 宽) 为标称值, 并包括引脚 (如适用)。



简化版应用示意图



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4 Revision History

注：以前版本的页码可能与当前版本的页码不同

| Changes from Revision B (October 2021) to Revision C (June 2023) | Page |
|---|-------------|
| • 将“器件信息”更改为“封装信息”表..... | 1 |
| • Added T _J Max Junction Temperature for V _{CC} ≤ 3.6 V in the <i>Absolute Maximum Ratings</i> | 4 |
| • Added T _A Operating free-air temperature at V _{CC} ≤ 3.6 V in the <i>Recommended Operating Conditions</i> | 4 |
| • Added I _{CC} Standby Mode at 85°C to 125°C in the <i>Electrical Characteristics</i> | 5 |

| Changes from Revision A (November 2019) to Revision B (October 2021) | Page |
|---|-------------|
| • 添加了特性：提供功能安全 | 1 |
| • 向汽车功能添加了等级 1，并删除了温度等级 3：-40°C 至 +85°C，T _A | 1 |
| • 将提到的旧术语实例全局更改为控制器和目标..... | 1 |

| Changes from Revision * (May 2019) to Revision A (November 2019) | Page |
|---|-------------|
| • V _{CC} value missing, added V _{CC} = 2.5 V in 图 9-1 | 20 |

5 Pin Configuration and Functions

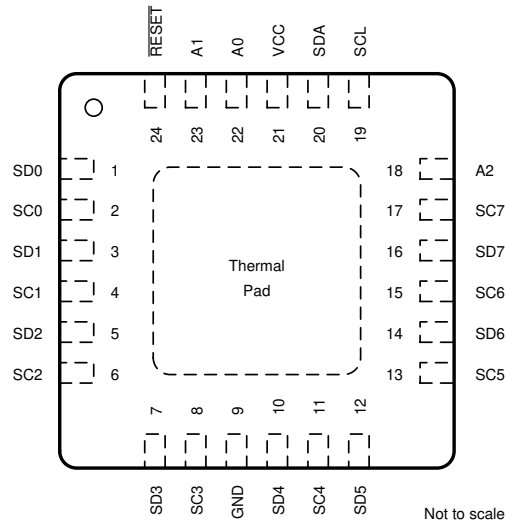


图 5-1. RGE Package, 24-Pin VQFN, Top View

表 5-1. Pin Functions

| PIN | | TYPE | DESCRIPTION |
|-------|-----------|-------|--|
| NAME | QFN (RGE) | | |
| A0 | 22 | I | Address input 0. Connect directly to V _{CC} or ground |
| A1 | 23 | I | Address input 1. Connect directly to V _{CC} or ground |
| A2 | 18 | I | Address input 2. Connect directly to V _{CC} or ground |
| GND | 9 | — | Ground |
| RESET | 24 | I | Active-low reset input. Connect to V _{CC} or V _{DPUM} ⁽¹⁾ through a pull-up resistor, if not used |
| SD0 | 1 | I/O | Serial data 0. Connect to V _{DPU0} ⁽¹⁾ through a pull-up resistor |
| SC0 | 2 | I/O | Serial clock 0. Connect to V _{DPU0} ⁽¹⁾ through a pull-up resistor |
| SD1 | 3 | I/O | Serial data 1. Connect to V _{DPU1} ⁽¹⁾ through a pull-up resistor |
| SC1 | 4 | I/O | Serial clock 1. Connect to V _{DPU1} ⁽¹⁾ through a pull-up resistor |
| SD2 | 5 | I/O | Serial data 2. Connect to V _{DPU2} ⁽¹⁾ through a pull-up resistor |
| SC2 | 6 | I/O | Serial clock 2. Connect to V _{DPU2} ⁽¹⁾ through a pull-up resistor |
| SD3 | 7 | I/O | Serial data 3. Connect to V _{DPU3} ⁽¹⁾ through a pull-up resistor |
| SC3 | 8 | I/O | Serial clock 3. Connect to V _{DPU3} ⁽¹⁾ through a pull-up resistor |
| SD4 | 10 | I/O | Serial data 4. Connect to V _{DPU4} ⁽¹⁾ through a pull-up resistor |
| SC4 | 11 | I/O | Serial clock 4. Connect to V _{DPU4} ⁽¹⁾ through a pull-up resistor |
| SD5 | 12 | I/O | Serial data 5. Connect to V _{DPU5} ⁽¹⁾ through a pull-up resistor |
| SC5 | 13 | I/O | Serial clock 5. Connect to V _{DPU5} ⁽¹⁾ through a pull-up resistor |
| SD6 | 14 | I/O | Serial data 6. Connect to V _{DPU6} ⁽¹⁾ through a pull-up resistor |
| SC6 | 15 | I/O | Serial clock 6. Connect to V _{DPU6} ⁽¹⁾ through a pull-up resistor |
| SD7 | 16 | I/O | Serial data 7. Connect to V _{DPU7} ⁽¹⁾ through a pull-up resistor |
| SC7 | 17 | I/O | Serial clock 7. Connect to V _{DPU7} ⁽¹⁾ through a pull-up resistor |
| SCL | 19 | I/O | Serial clock bus. Connect to V _{DPUM} ⁽¹⁾ through a pull-up resistor |
| SDA | 20 | I/O | Serial data bus. Connect to V _{DPUM} ⁽¹⁾ through a pull-up resistor |
| VCC | 21 | Power | Supply voltage |

(1) V_{DPUX} is the pull-up reference voltage for the associated data line. V_{DPUM} is the controller I²C reference voltage and V_{DPU0}-V_{DPU7} are the target channel reference voltages.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT | |
|------------------|------------------------------|-------------------------|-----|------|----|
| V _{CC} | Supply voltage | -0.5 | 7 | V | |
| V _I | Input voltage ⁽²⁾ | -0.5 | 7 | V | |
| I _I | Input current | -20 | 20 | mA | |
| I _O | Output current | -25 | | mA | |
| I _{CC} | Supply current | -100 | 100 | mA | |
| T _{stg} | Storage temperature | -65 | 150 | °C | |
| T _J | Max Junction Temperature | V _{CC} ≤ 3.6 V | | 130 | °C |
| | | V _{CC} ≤ 5.25V | | 90 | °C |

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

6.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
| V _(ESD) | Electrostatic discharge | Human body model (HBM), per AEC Q100-002 ⁽¹⁾ HBM ESD Classification Level 2 | ±2000 | V |
| | | Charged-device model (CDM), per AEC Q100-011 CDM ESD Classification Level C6 | ±1000 | |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.3 Recommended Operating Conditions

| | | | MIN | MAX | UNIT |
|-----------------|--------------------------------|-----------------------------------|-----------------------|-----------------------|------|
| V _{CC} | Supply voltage | -40 °C ≤ T _A ≤ 85 °C | 1.65 | 5.25 | V |
| V _{IH} | High-level input voltage | SCL, SDA | 0.7 × V _{CC} | 6 | V |
| | | A2 - A0, RESET | 0.7 × V _{CC} | V _{CC} + 0.5 | |
| V _{IL} | Low-level input voltage | SCL, SDA | -0.5 | 0.3 × V _{CC} | V |
| | | A2 - A0, RESET | -0.5 | 0.3 × V _{CC} | |
| T _A | Operating free-air temperature | 1.65 V ≤ V _{CC} ≤ 5.25 V | -40 | 85 | °C |
| T _A | Operating free-air temperature | 1.65 V ≤ V _{CC} ≤ 3.6 V | -40 | 125 | °C |

6.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | TCA9548A | UNIT |
|-------------------------------|--|------------|------|
| | | RGE (VQFN) | |
| | | 24 PINS | |
| R _{θJA} | Junction-to-ambient thermal resistance | 57.2 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 62.5 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 34.4 | °C/W |
| ψ _{JT} | Junction-to-top characterization parameter | 3.8 | °C/W |
| ψ _{JB} | Junction-to-board characterization parameter | 34.4 | °C/W |
| R _{θJC(bot)} | Junction-to-case (bottom) thermal resistance | 15.5 | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted), see note (1)

| PARAMETER | | TEST CONDITIONS | V _{CC} | MIN | TYP | MAX | UNIT | |
|-------------------------------------|--|--|---|--|-----|------|------|----|
| V _{PORR} | Power-on reset voltage, V _{CC} rising | No load, V _I = V _{CC} or GND ⁽⁴⁾ | | | 1.2 | 1.5 | V | |
| V _{PORF} | Power-on reset voltage, V _{CC} falling ⁽²⁾ | No load, V _I = V _{CC} or GND ⁽⁴⁾ | | 0.8 | 1 | | V | |
| V _{o(sw)} | Switch output voltage | V _{I(sw)} = V _{CC} , I _{SWout} = -100 μA | 5 V | | 3.6 | | V | |
| | | | 4.5 V to 5.25 V | 2.6 | | 4.5 | | |
| | | | 3.3 V | | 1.9 | | | |
| | | | 3 V to 3.6 V | 1.6 | | 2.8 | | |
| | | | 2.5 V | | 1.5 | | | |
| | | | 2.3 V to 2.7 V | 1.1 | | 2 | | |
| | | | 1.8 V | | 1.1 | | | |
| | | | 1.65 V to 1.95 V | 0.6 | | 1.25 | | |
| I _{OL} | SDA | V _{OL} = 0.4 V | 1.65 V to 5.25 V | 3 | | 6 | mA | |
| | | V _{OL} = 0.6 V | | 5 | | 9 | | |
| I _I | SCL, SDA | V _I = V _{CC} or GND ⁽⁴⁾ | 1.65 V to 5.25 V | -1 | | 1 | μA | |
| | SC7 - SC0, SD7 - SD0 | | | -1 | | 1 | | |
| | A2 - A0 | | | -1 | | 1 | | |
| | RESET | | | -1 | | 1 | | |
| I _{CC} | Operating mode | f _{SCL} = 400 kHz | V _I = V _{CC} or GND ⁽⁴⁾ , I _O = 0 | 5.25 V | | 50 | 80 | μA |
| | | | | 3.6 V | | 20 | 35 | |
| | | | | 2.7 V | | 11 | 20 | |
| | | | | 1.65 V | | 6 | 10 | |
| | | f _{SCL} = 100 kHz | V _I = V _{CC} or GND ⁽⁴⁾ , I _O = 0 | 5.25 V | | 9 | 30 | |
| | | | | 3.6 V | | 6 | 15 | |
| | | | | 2.7 V | | 4 | 8 | |
| | | | | 1.65 V | | 2 | 4 | |
| | Standby mode | Low inputs | V _I = GND ⁽⁴⁾ , I _O = 0 | 5.25 V | | 0.2 | 4 | |
| | | | | 3.6 V | | 0.1 | 2 | |
| | | | | 2.7 V | | 0.1 | 2 | |
| | | | | 1.65 V | | 0.1 | 1 | |
| | | High inputs | V _I = V _{CC} , I _O = 0 | 5.25 V | | 0.2 | 4 | |
| | | | | 3.6 V | | 0.1 | 2 | |
| | | | | 2.7 V | | 0.1 | 2 | |
| | | | | 1.65 V | | 0.1 | 1 | |
| Low inputs | V _I = V _{CC} or GND, I _O = 0, 85°C to 125°C | 3.6 V | | 1 | 2 | | | |
| | | 2.7 V | | 0.7 | 1.5 | | | |
| | | 1.65 V | | 0.4 | 1 | | | |
| | | 3.6 V | | 1 | 2 | | | |
| High inputs | V _I = V _{CC} or GND, I _O = 0, 85°C to 125°C | 2.7 V | | 0.7 | 1.5 | | | |
| | | 1.65 V | | 0.4 | 2 | | | |
| Δ I _{CC} | Supply-current change | SCL, SDA | 1.65 V to 5.25 V | SCL or SDA input at 0.6 V, Other inputs at V _{CC} or GND ⁽⁴⁾ | | 3 | 20 | μA |
| | | SCL or SDA input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND ⁽⁴⁾ | | 3 | 20 | | | |
| C _i | A2 - A0 | V _I = V _{CC} or GND ⁽⁴⁾ | 1.65 V to 5.25 V | 4 | | 5 | pF | |
| | RESET | | | 4 | | 5 | | |
| | SCL | | | 20 | | 28 | | |
| C _{io(off)} ⁽³⁾ | SDA | V _I = V _{CC} or GND ⁽⁴⁾ , Switch OFF | 1.65 V to 5.25 V | 20 | | 28 | pF | |
| | SC7 - SC0, SD7 - SD0 | | | 5.5 | | 7.5 | | |

6.5 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted), see note ⁽¹⁾

| PARAMETER | | TEST CONDITIONS | V _{CC} | MIN | TYP | MAX | UNIT |
|-----------------|----------------------|--|------------------|-----|-----|-----|------|
| R _{ON} | Switch-on resistance | V _O = 0.4 V, I _O = 15 mA | 4.5 V to 5.25 V | 4 | 10 | 25 | Ω |
| | | | 3 V to 3.6 V | 5 | 12 | 35 | |
| | | V _O = 0.4 V, I _O = 10 mA | 2.3 V to 2.7 V | 7 | 15 | 45 | |
| | | | 1.65 V to 1.95 V | 10 | 25 | 70 | |

(1) For operation between specified voltage ranges, refer to the worst-case parameter in both applicable ranges.

(2) The power-on reset circuit resets the I²C bus logic with V_{CC} < V_{PORF}.

(3) C_{iO(ON)} depends on internal capacitance and external capacitance added to the SCn lines when channel(s) are ON.

(4) RESET = V_{CC} (held high) when all other input voltages, V_I = GND.

6.6 I²C Interface Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 7-1](#))

| | | | MIN | MAX | UNIT |
|------------------------|---|---|--------------------------------|------|------|
| STANDARD MODE | | | | | |
| f _{scl} | I ² C clock frequency | | 0 | 100 | kHz |
| t _{sch} | I ² C clock high time | | 4 | | μs |
| t _{scl} | I ² C clock low time | | 4.7 | | μs |
| t _{sp} | I ² C spike time | | | 50 | ns |
| t _{sds} | I ² C serial-data setup time | | 250 | | ns |
| t _{sdh} | I ² C serial-data hold time | | 0 ⁽¹⁾ | | μs |
| t _{icr} | I ² C input rise time | | | 1000 | ns |
| t _{icf} | I ² C input fall time | | | 300 | ns |
| t _{ocf} | I ² C output (SDn) fall time (10 pF to 400 pF bus) | | | 300 | ns |
| t _{buf} | I ² C bus free time between stop and start | | 4.7 | | μs |
| t _{sts} | I ² C start or repeated start condition setup | | 4.7 | | μs |
| t _{sth} | I ² C start or repeated start condition hold | | 4 | | μs |
| t _{sps} | I ² C stop condition setup | | 4 | | μs |
| t _{vdL(Data)} | Valid-data time (high to low) ⁽²⁾ | SCL low to SDA output low valid | | 1 | μs |
| t _{vdH(Data)} | Valid-data time (low to high) ⁽²⁾ | SCL low to SDA output high valid | | 0.6 | μs |
| t _{vd(ack)} | Valid-data time of ACK condition | ACK signal from SCL low to SDA output low | | 1 | μs |
| C _b | I ² C bus capacitive load | | | 400 | pF |
| FAST MODE | | | | | |
| f _{scl} | I ² C clock frequency | | 0 | 400 | kHz |
| t _{sch} | I ² C clock high time | | 0.6 | | μs |
| t _{scl} | I ² C clock low time | | 1.3 | | μs |
| t _{sp} | I ² C spike time | | | 50 | ns |
| t _{sds} | I ² C serial-data setup time | | 100 | | ns |
| t _{sdh} | I ² C serial-data hold time | | 0 ⁽¹⁾ | | μs |
| t _{icr} | I ² C input rise time | | 20 | 300 | ns |
| t _{icf} | I ² C input fall time | | 20 × (V _{CC} / 5.5 V) | 300 | ns |
| t _{ocf} | I ² C output (SDn) fall time (10 pF to 400 pF bus) | | 20 × (V _{CC} / 5.5 V) | 300 | ns |
| t _{buf} | I ² C bus free time between stop and start | | 1.3 | | μs |
| t _{sts} | I ² C start or repeated start condition setup | | 0.6 | | μs |
| t _{sth} | I ² C start or repeated start condition hold | | 0.6 | | μs |
| t _{sps} | I ² C stop condition setup | | 0.6 | | μs |
| t _{vdL(Data)} | Valid-data time (high to low) ⁽²⁾ | SCL low to SDA output low valid | | 1 | μs |

6.6 I²C Interface Timing Requirements (continued)

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 7-1](#))

| | | | MIN | MAX | UNIT |
|------------------------|--|---|-----|-----|------|
| t _{vdH(Data)} | Valid-data time (low to high) ⁽²⁾ | SCL low to SDA output high valid | | 0.6 | μs |
| t _{vd(ack)} | Valid-data time of ACK condition | ACK signal from SCL low to SDA output low | | 1 | μs |
| C _b | I ² C bus capacitive load | | | 400 | pF |

- (1) A device internally must provide a hold time of at least 300 ns for the SDA signal (referred to the V_{IH} min of the SCL signal), to bridge the undefined region of the falling edge of SCL.
- (2) Data taken using a 1 kΩ pull-up resistor and 50 pF load (see [Figure 7-2](#))

6.7 Reset Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | MIN | MAX | UNIT |
|-----------------------|-----------------------------------|-----|-----|------|
| t _{W(L)} | Pulse duration, RESET low | 6 | | ns |
| t _{REC(STA)} | Recovery time from RESET to start | 0 | | ns |

6.8 Switching Characteristics

over recommended operating free-air temperature range, C_L ≤ 100 pF (unless otherwise noted) (see [Figure 7-1](#))

| PARAMETER | | | FROM (INPUT) | TO (OUTPUT) | MIN | MAX | UNIT |
|---------------------------------|------------------------|--|--------------|-------------|-----|-----|------|
| t _{pd} ⁽¹⁾ | Propagation delay time | R _{ON} = 20 Ω, C _L = 15 pF | SDA or SCL | SDn or SCn | 0.3 | | ns |
| | | R _{ON} = 20 Ω, C _L = 50 pF | | | 1 | | |
| t _{rst} ⁽²⁾ | RESET time (SDA clear) | | RESET | SDA | 500 | | ns |

- (1) The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
- (2) t_{rst} is the propagation delay measured from the time the RESET pin is first asserted low to the time the SDA pin is asserted high, signaling a stop condition. It must be a minimum of t_{WL}.

6.9 Typical Characteristics

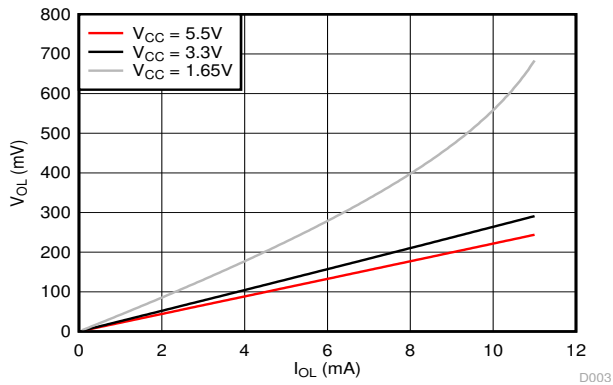


图 6-1. SDA Output Low Voltage (V_{OL}) vs Load Current (I_{OL}) at Three V_{CC} Levels

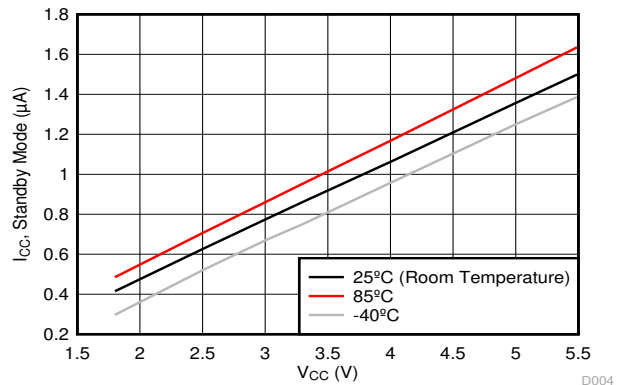


图 6-2. Standby Current (I_{CC}) vs Supply Voltage (V_{CC}) at three temperatures

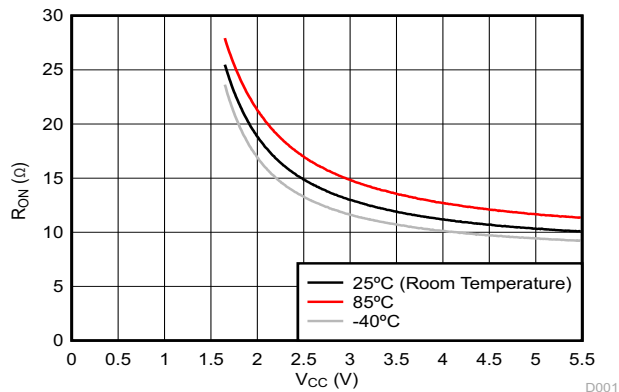
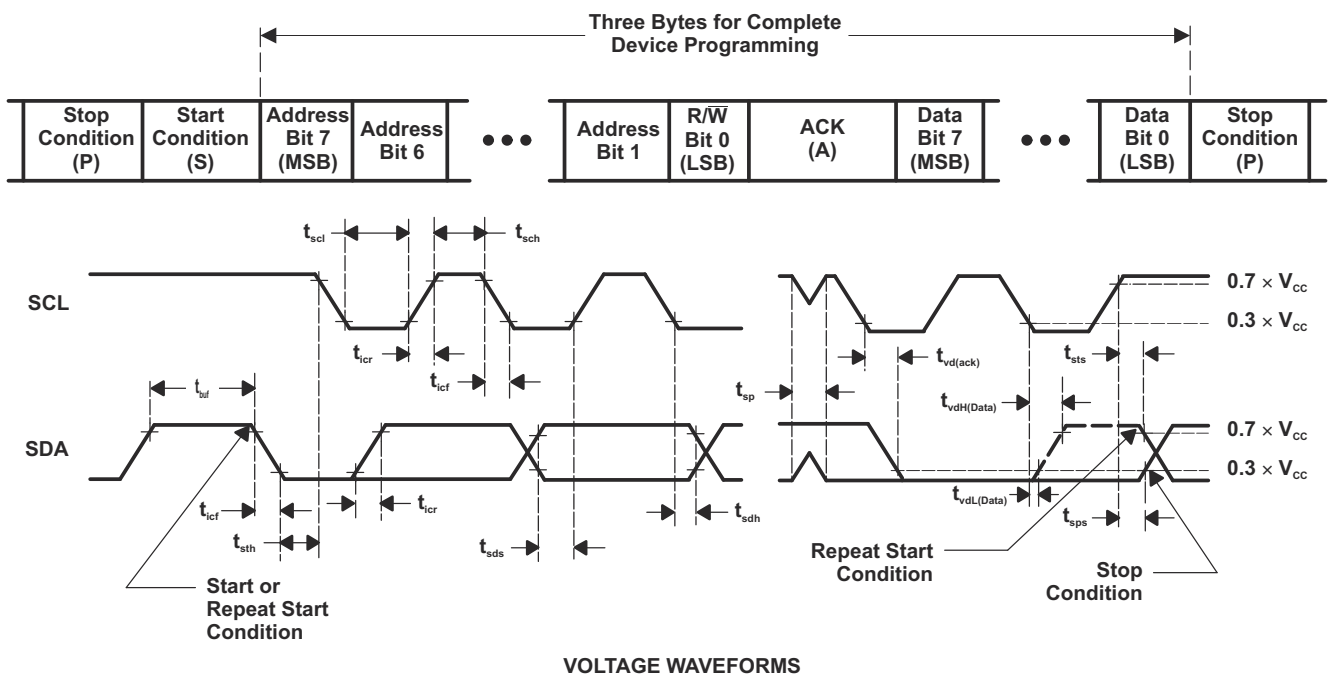
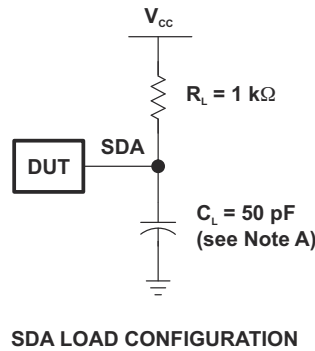


图 6-3. On-Resistance (R_{ON}) vs Supply Voltage (V_{CC}) at three temperatures

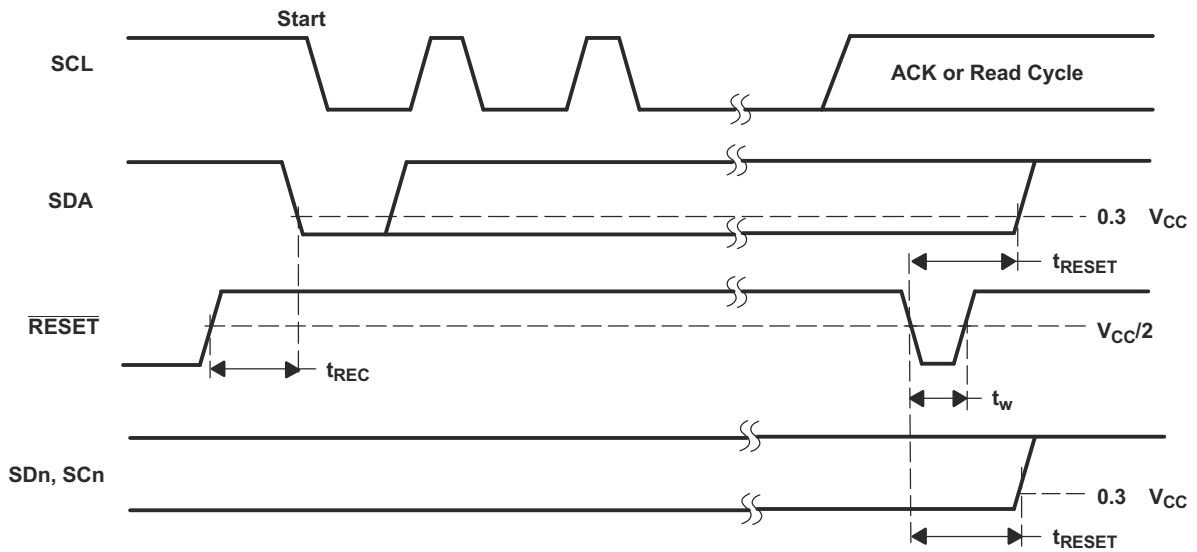
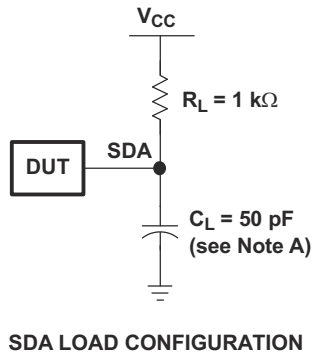
7 Parameter Measurement Information



| BYTE | DESCRIPTION |
|------|--------------------------|
| 1 | I ² C address |
| 2, 3 | P-port data |

- A. C_L includes probe and jig capacitance.
- B. All inputs are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_0 = 50 \Omega$, $t_r/t_f \leq 30$ ns.
- C. Not all parameters and waveforms are applicable to all devices.

图 7-1. I²C Load Circuit and Voltage Waveforms



- A. C_L includes probe and jig capacitance.
- B. All inputs are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r/t_f \leq 30\text{ ns}$.
- C. I/Os are configured as inputs.
- D. Not all parameters and waveforms are applicable to all devices.

图 7-2. Reset Load Circuit and Voltage Waveforms

8 Detailed Description

8.1 Overview

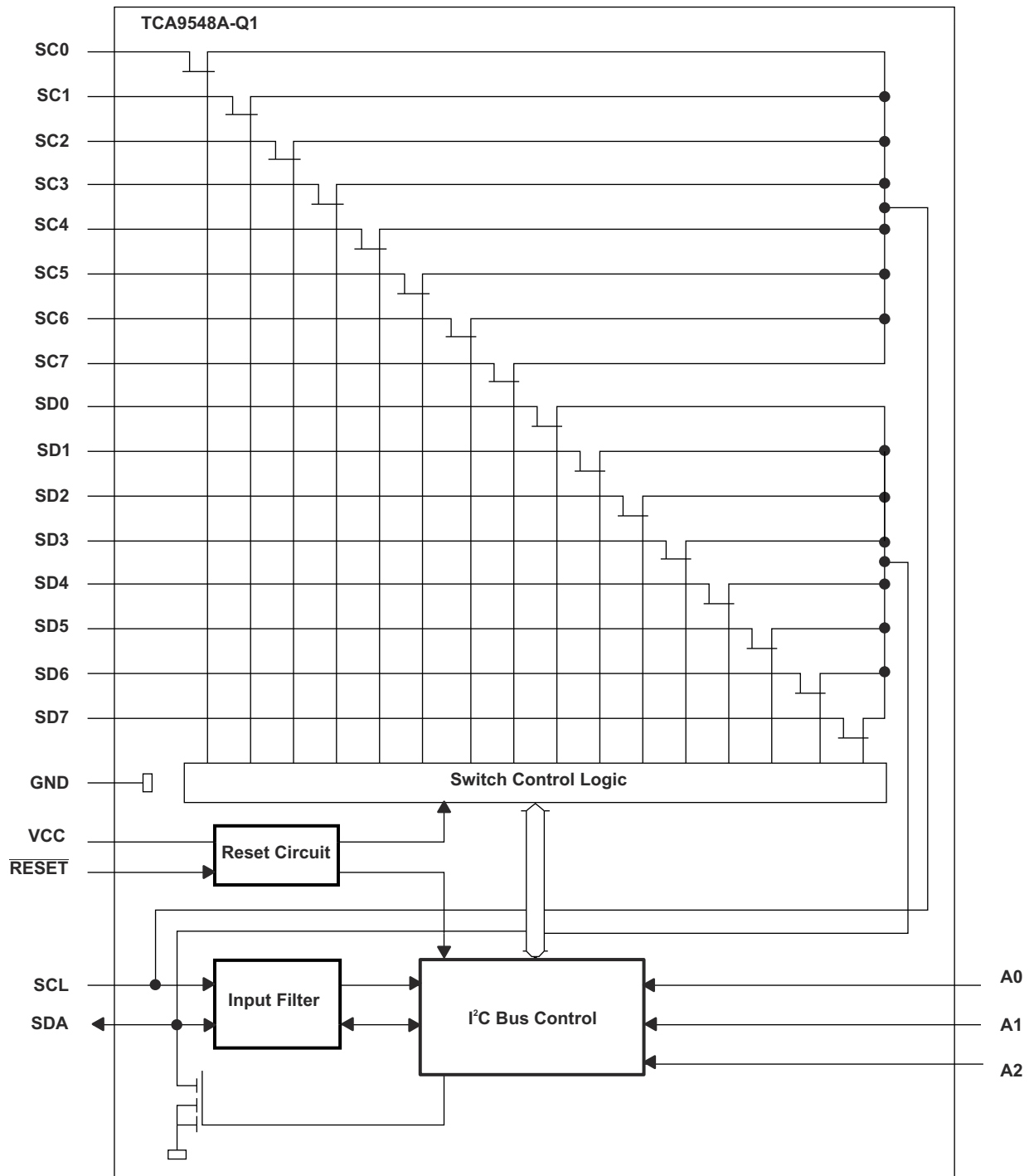
The TCA9548A-Q1 is an 8-channel, bidirectional translating I²C switch. The controller SCL/SDA signal pair is directed to eight channels of target devices, SC0/SD0-SC7/SD7. Any individual downstream channel can be selected as well as any combination of the eight channels.

The device offers an active-low $\overline{\text{RESET}}$ input which resets the state machine and allows the TCA9548A-Q1 to recover if one of the downstream I²C buses get stuck in a low state. The state machine of the device can also be reset by cycling the power supply, V_{CC}, also known as a power-on reset (POR). Both the $\overline{\text{RESET}}$ function and a POR cause all channels to be deselected.

The connections of the I²C data path are controlled by the same I²C controller device that is switched to communicate with multiple I²C targets. After the successful acknowledgment of the target address (hardware selectable by A0, A1, and A2 pins), a single 8-bit control register is written to or read from to determine the selected channels.

The TCA9548A-Q1 may also be used for voltage translation, allowing the use of different bus voltages on each SC_n/SD_n pair such that 1.8 V, 2.5 V, or 3.3 V parts can communicate with 5 V parts. This is achieved by using external pull-up resistors to pull the bus up to the desired voltage for the controller and each target channel.

8.2 Functional Block Diagram



8.3 Feature Description

The TCA9548A-Q1 is an 8-channel, bidirectional translating switch for I²C buses that supports Standard-Mode (100 kHz) and Fast-Mode (400 kHz) operation. The TCA9548A-Q1 features I²C control using a single 8-bit control register in which each bit controls the enabling and disabling of one of the corresponding 8 switch channels for I²C data flow. Depending on the application, voltage translation of the I²C bus can also be achieved using the TCA9548A-Q1 to allow 1.8 V, 2.5 V, or 3.3 V parts to communicate with 5 V parts. Additionally, in the

event that communication on the I²C bus enters a fault state, the TCA9548A-Q1 can be reset to resume normal operation using the RESET pin feature or by a power-on reset which results from cycling power to the device.

8.4 Device Functional Modes

8.4.1 RESET Input

The RESET input is an active-low signal that may be used to recover from a bus-fault condition. When this signal is asserted low for a minimum of t_{WL} , the TCA9548A-Q1 resets its registers and I²C state machine and deselected all channels. The RESET input must be connected to V_{CC} through a pull-up resistor.

8.4.2 Power-On Reset

When power is applied to the VCC pin, an internal power-on reset holds the TCA9548A-Q1 in a reset condition until V_{CC} has reached V_{PORR}. At this point, the reset condition is released, and the TCA9548A-Q1 registers and I²C state machine are initialized to their default states, all zeroes, causing all the channels to be deselected. Thereafter, V_{CC} must be lowered below V_{PORF} to reset the device.

8.5 Programming

8.5.1 I²C Interface

The TCA9548A-Q1 has a standard bidirectional I²C interface that is controlled by a controller device in order to be configured or read the status of this device. Each target on the I²C bus has a specific device address to differentiate between other target devices that are on the same I²C bus. Many target devices require configuration upon startup to set the behavior of the device. This is typically done when the controller accesses internal register maps of the target, which have unique register addresses. A device can have one or multiple registers where data is stored, written, or read.

The physical I²C interface consists of the serial clock (SCL) and serial data (SDA) lines. Both SDA and SCL lines must be connected to V_{CC} through a pull-up resistor. The size of the pull-up resistor is determined by the amount of capacitance on the I²C lines. (For further details, see the [I²C Pull-up Resistor Calculation](#) application report. Data transfer may be initiated only when the bus is idle. A bus is considered idle if both SDA and SCL lines are high after a STOP condition (See [图 8-1](#) and [图 8-2](#)).

The following is the general procedure for a controller to access a target device:

1. If a controller wants to send data to a target:
 - Controller-transmitter sends a START condition and addresses the target-receiver.
 - Controller-transmitter sends data to target-receiver.
 - Controller-transmitter terminates the transfer with a STOP condition.
2. If a controller wants to receive or read data from a target:
 - Controller-receiver sends a START condition and addresses the target-transmitter.
 - Controller-receiver sends the requested register to read to target-transmitter.
 - Controller-receiver receives data from the target-transmitter.

- Controller-receiver terminates the transfer with a STOP condition.

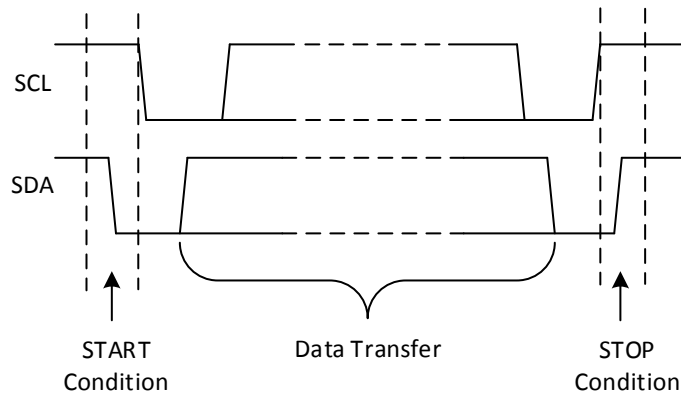


图 8-1. Definition of Start and Stop Conditions

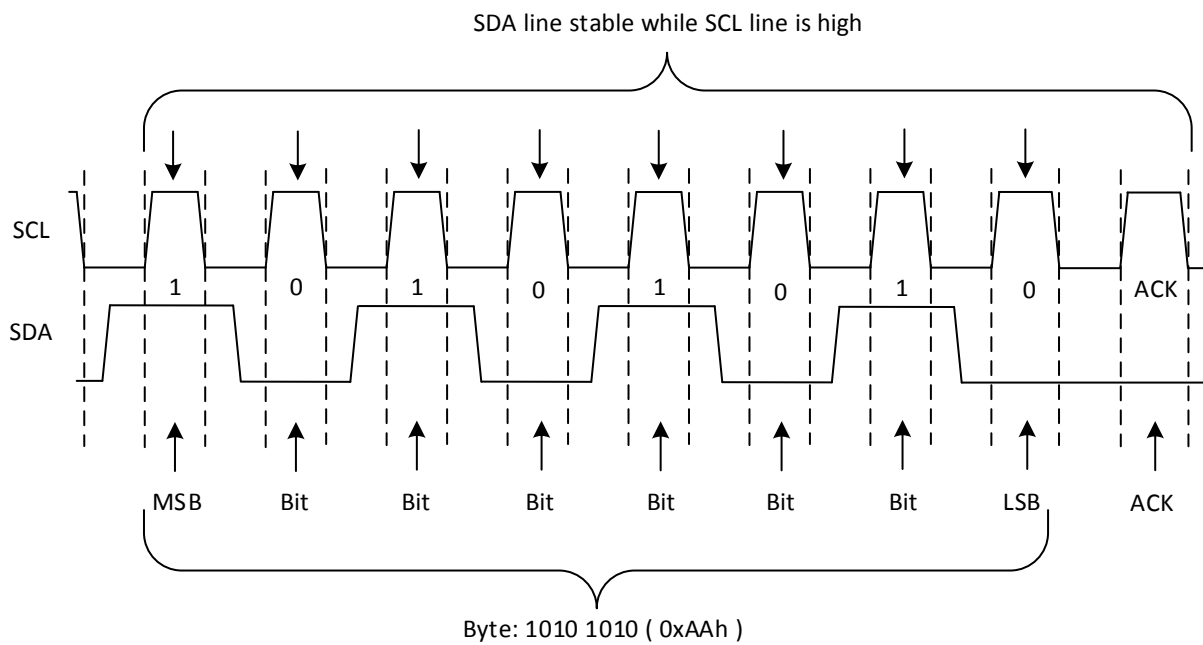


图 8-2. Bit Transfer

8.5.2 Device Address

图 8-3 shows the address byte of the TCA9548A-Q1.

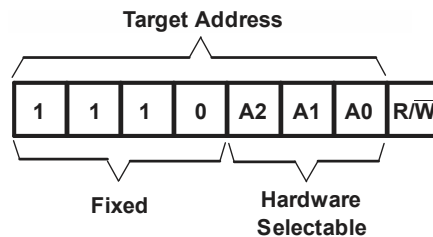


图 8-3. TCA9548A-Q1 Address

The last bit of the target address defines the operation (read or write) to be performed. When it is high (1), a read is selected, while a low (0) selects a write operation.

表 8-1 shows the TCA9548A-Q1 address reference.

表 8-1. Address Reference

| INPUTS | | | I ² C BUS TARGET ADDRESS |
|--------|----|----|-------------------------------------|
| A2 | A1 | A0 | |
| L | L | L | 112 (decimal), 70 (hexadecimal) |
| L | L | H | 113 (decimal), 71 (hexadecimal) |
| L | H | L | 114 (decimal), 72 (hexadecimal) |
| L | H | H | 115 (decimal), 73 (hexadecimal) |
| H | L | L | 116 (decimal), 74 (hexadecimal) |
| H | L | H | 117 (decimal), 75 (hexadecimal) |
| H | H | L | 118 (decimal), 76 (hexadecimal) |
| H | H | H | 119 (decimal), 77 (hexadecimal) |

8.5.3 Bus Transactions

Data must be sent to and received from the target devices, and this is accomplished by reading from or writing to registers in the target device.

Registers are locations in the memory of the target which contain information, whether it be the configuration information or some sampled data to send back to the controller. The controller must write information to these registers in order to instruct the target device to perform a task.

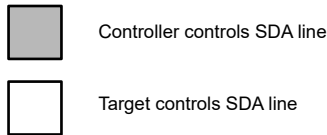
While it is common to have registers in I²C targets, note that not all target devices have registers. Some devices are simple and contain only 1 register, which may be written to directly by sending the register data immediately after the target address, instead of addressing a register. The TCA9548A-Q1 is example of a single-register device, which is controlled via I²C commands. Since it has 1 bit to enable or disable a channel, there is only 1 register needed, and the controller merely writes the register data after the target address, skipping the register number.

8.5.3.1 Writes

To write on the I²C bus, the controller sends a START condition on the bus with the address of the target, as well as the last bit (the R/ \bar{W} bit) set to 0, which signifies a write. The target acknowledges, letting the controller know it is ready. After this, the controller starts sending the control register data to the target until the controller has sent all the data necessary (which is sometimes only a single byte), and the controller terminates the transmission with a STOP condition.

There is no limit to the number of bytes sent, but the last byte sent is what is in the register.

图 8-4 shows an example of writing a single byte to a target register.



Write to one register in a device

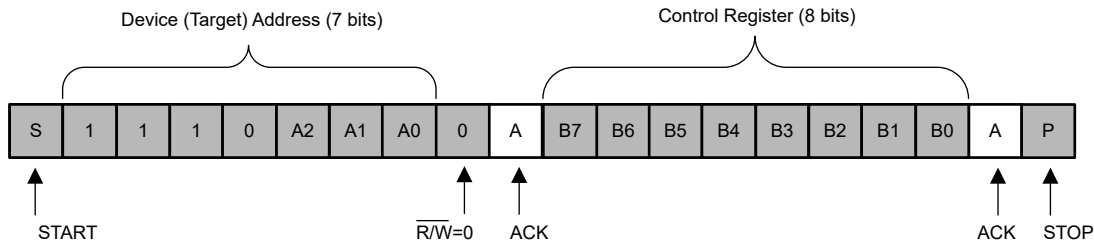


图 8-4. Write to Register

8.5.3.2 Reads

Reading from a target is very similar to writing, but the controller sends a START condition, followed by the target address with the R/ W bit set to 1 (signifying a read). The target acknowledges the read request, and the controller releases the SDA bus but continues supplying the clock to the target. During this part of the transaction, the controller becomes the controller-receiver, and the target becomes the target-transmitter.

The controller continues to send out the clock pulses, but releases the SDA line so that the target can transmit data. At the end of every byte of data, the controller sends an ACK to the target, letting the target know that it is ready for more data. Once the controller has received the number of bytes it is expecting, it sends a NACK, signaling to the target to halt communications and release the bus. The controller follows this up with a STOP condition.

图 8-5 shows an example of reading a single byte from a target register.

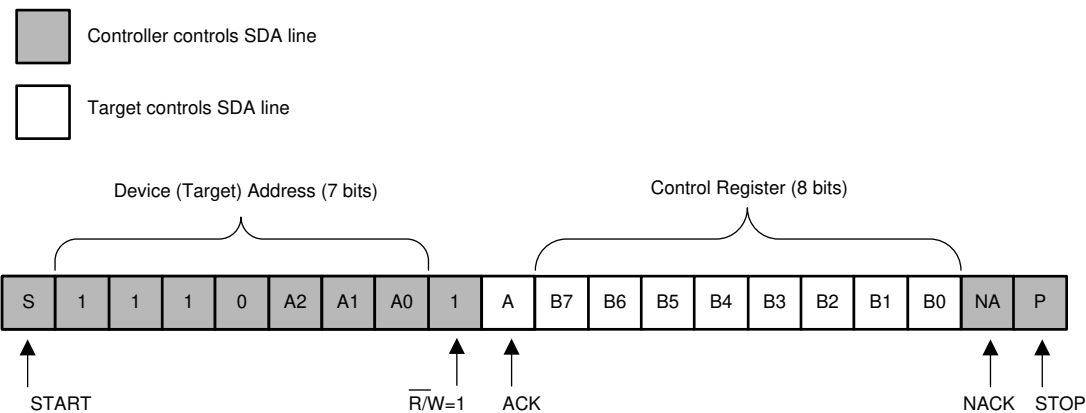


图 8-5. Read from Control Register

8.5.4 Control Register

Following the successful acknowledgment of the address byte, the bus controller sends a command byte that is stored in the control register in the TCA9548A-Q1 (see 图 8-6). This register can be written and read via the I²C bus. Each bit in the command byte corresponds to a SCn/SDn channel and a high (or 1) selects this channel. Multiple SCn/SDn channels may be selected at the same time. When a channel is selected, the channel becomes active after a stop condition has been placed on the I²C bus. This ensures that all SCn/SDn lines are in a high state when the channel is made active, so that no false conditions are generated at the time of

connection. A stop condition always must occur immediately after the acknowledge cycle. If multiple bytes are received by the TCA9548A-Q1, it saves the last byte received.

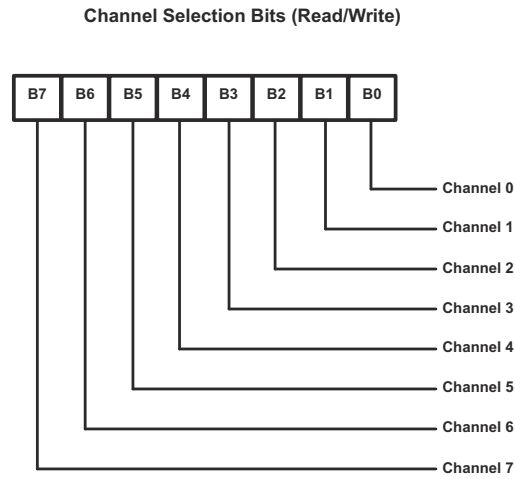


图 8-6. Control Register

表 8-2 shows the TCA9548A-Q1 Command Byte Definition.

表 8-2. Command Byte Definition

| CONTROL REGISTER BITS | | | | | | | | COMMAND |
|-----------------------|----|----|----|----|----|----|----|---|
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 | |
| X | X | X | X | X | X | X | 0 | Channel 0 disabled |
| | | | | | | | 1 | Channel 0 enabled |
| X | X | X | X | X | X | X | 0 | Channel 1 disabled |
| | | | | | | | 1 | Channel 1 enabled |
| X | X | X | X | X | X | X | 0 | Channel 2 disabled |
| | | | | | | | 1 | Channel 2 enabled |
| X | X | X | X | X | X | X | 0 | Channel 3 disabled |
| | | | | | | | 1 | Channel 3 enabled |
| X | X | X | X | X | X | X | 0 | Channel 4 disabled |
| | | | | | | | 1 | Channel 4 enabled |
| X | X | X | X | X | X | X | 0 | Channel 5 disabled |
| | | | | | | | 1 | Channel 5 enabled |
| X | X | X | X | X | X | X | 0 | Channel 6 disabled |
| | | | | | | | 1 | Channel 6 enabled |
| 0 | X | X | X | X | X | X | 0 | Channel 7 disabled |
| | | | | | | | 1 | Channel 7 enabled |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | No channel selected, power-up/reset default state |

8.5.5 RESET Input

The $\overline{\text{RESET}}$ input is an active-low signal that may be used to recover from a bus-fault condition. When this signal is asserted low for a minimum of t_{WL} , the TCA9548A-Q1 resets its registers and I²C state machine and deselects all channels. The $\overline{\text{RESET}}$ input must be connected to V_{CC} through a pull-up resistor.

8.5.6 Power-On Reset

When power (from 0 V) is applied to V_{CC} , an internal power-on reset holds the TCA9548A-Q1 in a reset condition until V_{CC} has reached V_{POR} . At that point, the reset condition is released and the TCA9548A-Q1 registers and I²C state machine initialize to their default states. After that, V_{CC} must be lowered to below V_{POR} and then back up to the operating voltage for a power-reset cycle.

Application and Implementation

备注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

Applications of the TCA9548A-Q1 contain an I²C (or SMBus) controller device and up to eight I²C target devices. The downstream channels are ideally used to resolve I²C target address conflicts. For example, if eight identical digital temperature sensors are needed in the application, one sensor can be connected at each channel: 0-7. When the temperature at a specific location needs to be read, the appropriate channel can be enabled and all other channels switched off, the data can be retrieved, and the I²C controller can move on and read the next channel.

In an application where the I²C bus contains many additional target devices that do not result in I²C target address conflicts, these target devices can be connected to any desired channel to distribute the total bus capacitance across multiple channels. If multiple switches are enabled simultaneously, additional design requirements must be considered (see the [Design Requirements](#) section and [Detailed Design Procedure](#) section).

9.2 Typical Application

Figure 9-1 shows an application in which the TCA9548A-Q1 can be used.

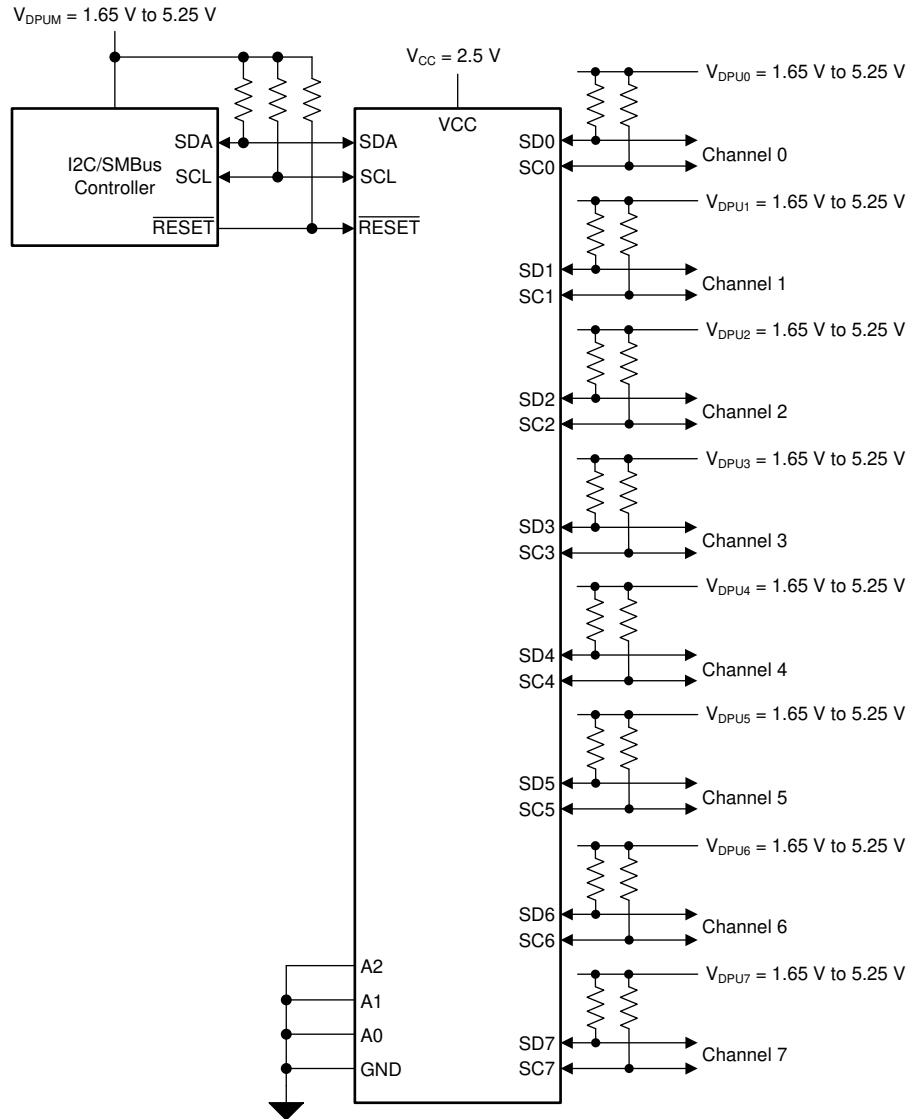


Figure 9-1. Typical Application Schematic

9.2.1 Design Requirements

A typical application of the TCA9548A-Q1 contains one or more data pull-up voltages, V_{DPUX} , one for the controller device (V_{DPUM}) and one for each of the selectable target channels ($V_{DPU0} - V_{DPU7}$). In the event where the controller device and all target devices operate at the same voltage, then $V_{DPUM} = V_{DPUX} = V_{CC}$. In an application where voltage translation is necessary, additional design requirements must be considered to determine an appropriate V_{CC} voltage.

The A0, A1, and A2 pins are hardware selectable to control the target address of the TCA9548A-Q1. These pins may be tied directly to GND or V_{CC} in the application.

If multiple target channels are activated simultaneously in the application, then the total I_{OL} from SCL/SDA to GND on the controller side is the sum of the currents through all pull-up resistors, R_p .

The pass-gate transistors of the TCA9548A-Q1 are constructed such that the V_{CC} voltage can be used to limit the maximum voltage that is passed from one I²C bus to another.

图 9-2 shows the voltage characteristics of the pass-gate transistors (note that the graph was generated using data specified in the [Electrical Characteristics](#) table). In order for the TCA9548A-Q1 to act as a voltage translator, the V_{pass} voltage must be equal to or lower than the lowest bus voltage. For example, if the main bus is running at 5 V and the downstream buses are 3.3 V and 2.7 V, V_{pass} must be equal to or below 2.7 V to effectively clamp the downstream bus voltages. As shown in 图 9-2, $V_{pass(max)}$ is 2.7 V when the TCA9548A-Q1 supply voltage is 4 V or lower, so the TCA9548A-Q1 supply voltage could be set to 3.3 V. Pull-up resistors then can be used to bring the bus voltages to their appropriate levels (see 图 9-1).

9.2.2 Detailed Design Procedure

Once all the targets are assigned to the appropriate target channels and bus voltages are identified, the pull-up resistors, R_p , for each of the buses need to be selected appropriately. The minimum pull-up resistance is a function of V_{DPUX} , $V_{OL(max)}$, and I_{OL} as shown in 方程式 1:

$$R_{p(min)} = \frac{V_{DPUX} - V_{OL(max)}}{I_{OL}} \quad (1)$$

The maximum pull-up resistance is a function of the maximum rise time, t_r (300 ns for fast-mode operation, $f_{SCL} = 400$ kHz) and bus capacitance, C_b as shown in 方程式 2:

$$R_{p(max)} = \frac{t_r}{0.8473 \times C_b} \quad (2)$$

The maximum bus capacitance for an I²C bus must not exceed 400 pF for fast-mode operation. The bus capacitance can be approximated by adding the capacitance of the TCA9548A-Q1, $C_{i0(OFF)}$, the capacitance of wires, connections and traces, and the capacitance of each individual target on a given channel. If multiple channels are activated simultaneously, each of the targets on all channels contribute to total bus capacitance.

9.2.3 Application Curves

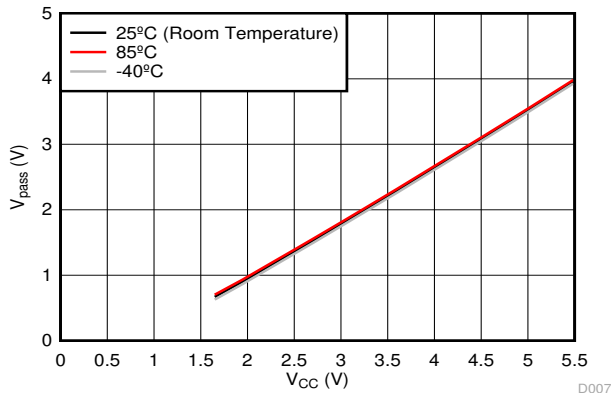


图 9-2. Pass-Gate Voltage (V_{pass}) vs Supply Voltage (V_{CC}) at Three Temperature Points

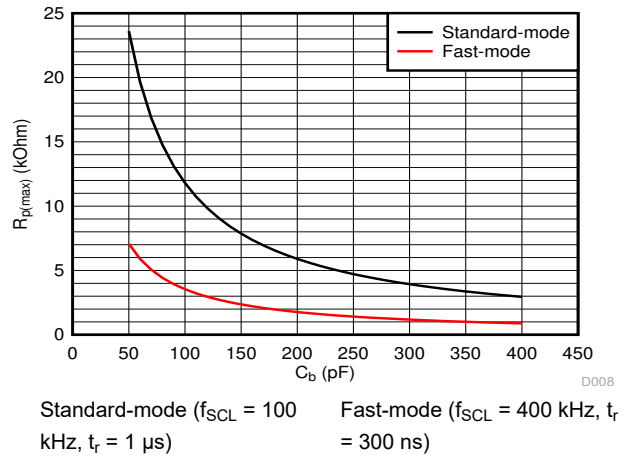
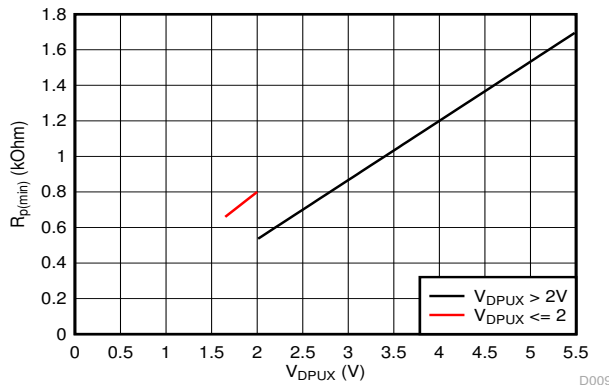


图 9-3. Maximum Pull-up Resistance ($R_{p(max)}$) vs Bus Capacitance (C_b)
Standard-mode ($f_{SCL} = 100$ kHz, $t_r = 1 \mu s$) Fast-mode ($f_{SCL} = 400$ kHz, $t_r = 300$ ns)



$V_{OL} = 0.2 \times V_{DPUX}$, $I_{OL} = 2$ mA when $V_{DPUX} \leq 2$ V
 $V_{OL} = 0.4$ V, $I_{OL} = 3$ mA when $V_{DPUX} > 2$ V

图 9-4. Minimum Pull-up Resistance ($R_{p(min)}$) vs Pull-up Reference Voltage (V_{DPUX})

Power Supply Recommendations

The operating power-supply voltage range of the TCA9548A-Q1 is 1.65 V to 5.25 V applied at the VCC pin. When the TCA9548A-Q1 is powered on for the first time or anytime the device must be reset by cycling the power supply, the power-on reset requirements must be followed to ensure the I²C bus logic is initialized properly.

9.1 Power-On Reset Requirements

In the event of a glitch or data corruption, TCA9548A-Q1 can be reset to its default conditions by using the power-on reset feature. Power-on reset requires that the device go through a power cycle to be completely reset. This reset also happens when the device is powered on for the first time in an application.

A power-on reset is shown in [图 9-1](#).

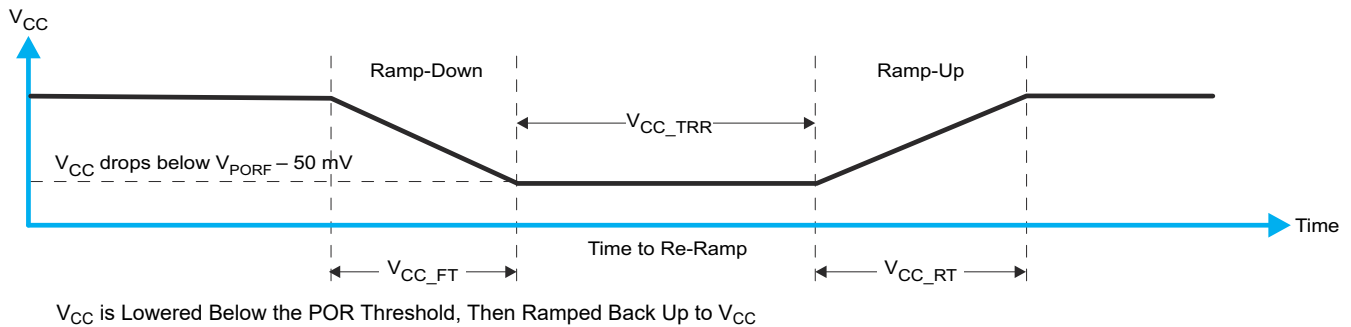


图 9-1. Power-On Reset Waveform

表 9-1 specifies the performance of the power-on reset feature for TCA9548A-Q1 for both types of power-on reset.

表 9-1. Recommended Supply Sequencing and Ramp Rates⁽¹⁾

| PARAMETER | | | MIN | MAX | UNIT |
|---------------------|--|---------------------------|-----|-----|------|
| V _{CC_FT} | Fall time | See 图 9-1 | 1 | 100 | ms |
| V _{CC_RT} | Rise time | See 图 9-1 | 0.1 | 100 | ms |
| V _{CC_TRR} | Time to re-ramp (when V _{CC} drops below V _{PORF(min)} - 50 mV or when V _{CC} drops to GND) | See 图 9-1 | 40 | | μs |
| V _{CC_GH} | Level that V _{CC} can glitch down to, but not cause a functional disruption when V _{CC_GW} = 1 μs | See 图 9-2 | | 1.2 | V |
| V _{CC_GW} | Glitch width that does not cause a functional disruption when V _{CC_GH} = 0.5 × V _{CC} | See 图 9-2 | | 10 | μs |

(1) All supply sequencing and ramp rate values are measured at T_A = 25°C

Glitches in the power supply can also affect the power-on reset performance of this device. The glitch width (V_{CC_GW}) and height (V_{CC_GH}) are dependent on each other. The bypass capacitance, source impedance, and device impedance are factors that affect power-on reset performance. [图 9-2](#) and [表 9-1](#) provide more information on how to measure these specifications.

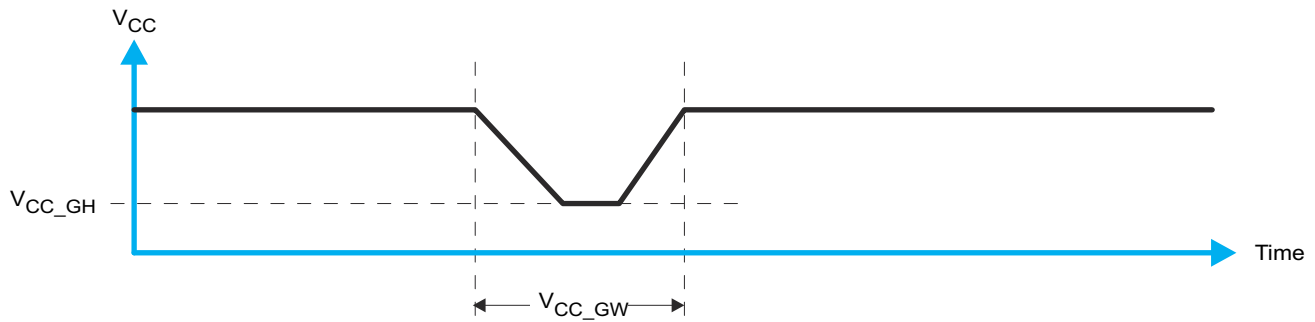


图 9-2. Glitch Width and Glitch Height

V_{POR} is critical to the power-on reset. V_{POR} is the voltage level at which the reset condition is released and all the registers and the I²C/SMBus state machine are initialized to their default states. The value of V_{POR} differs based on the V_{CC} being lowered to or from 0. 图 9-3 和 表 9-1 提供更多信息。图 9-3 和 表 9-1 提供更多信息。

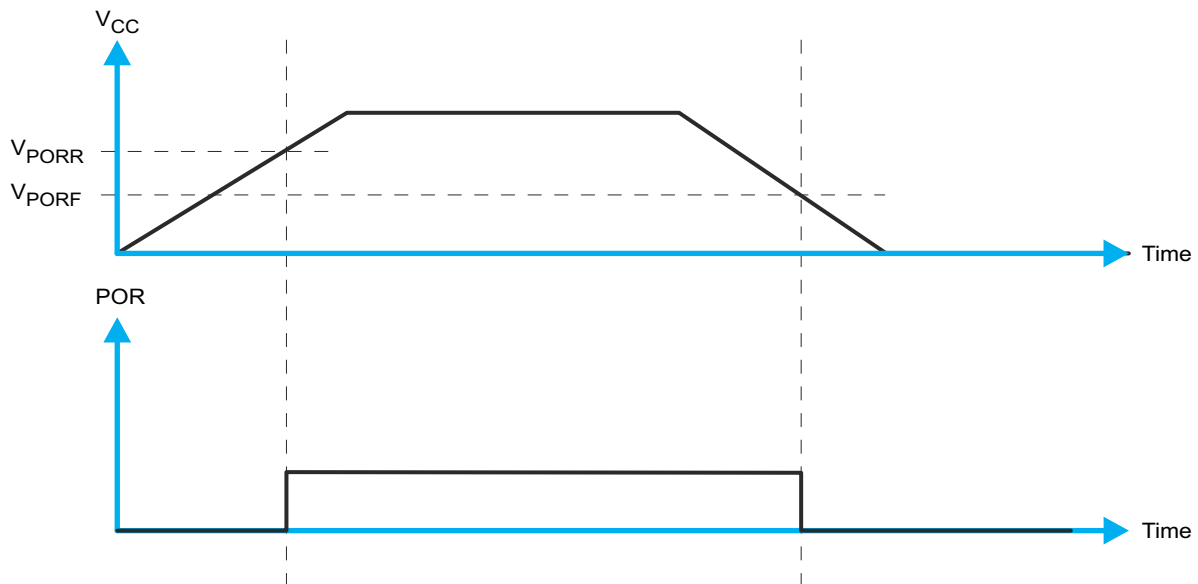


图 9-3. V_{POR} Example

9 Layout

9.1 Layout Guidelines

For PCB layout of the TCA9548A-Q1, common PCB layout practices must be followed but additional concerns related to high-speed data transfer such as matched impedances and differential pairs are not a concern for I²C signal speeds. It is common to have a dedicated ground plane on an inner layer of the board and pins that are connected to ground must have a low-impedance path to the ground plane in the form of wide polygon pours and multiple vias. Bypass and decoupling capacitors are commonly used to control the voltage on the VCC pin, using a larger capacitor to provide additional power in the event of a short power supply glitch and a smaller capacitor to filter out high-frequency ripple.

In an application where voltage translation is not required, all V_{DPUX} voltages and V_{CC} could be at the same potential and a single copper plane could connect all of the pull-up resistors to the appropriate reference voltage. In an application where voltage translation is required, V_{DPUM} and V_{DPU0} - V_{DPU7}, may all be on the same layer of the board with split planes to isolate different voltage potentials.

To reduce the total I²C bus capacitance added by PCB parasitics, data lines (SC_n and SD_n) must be a short as possible and the widths of the traces must also be minimized (for example, 5-10 mils depending on copper weight).

9.2 Layout Example

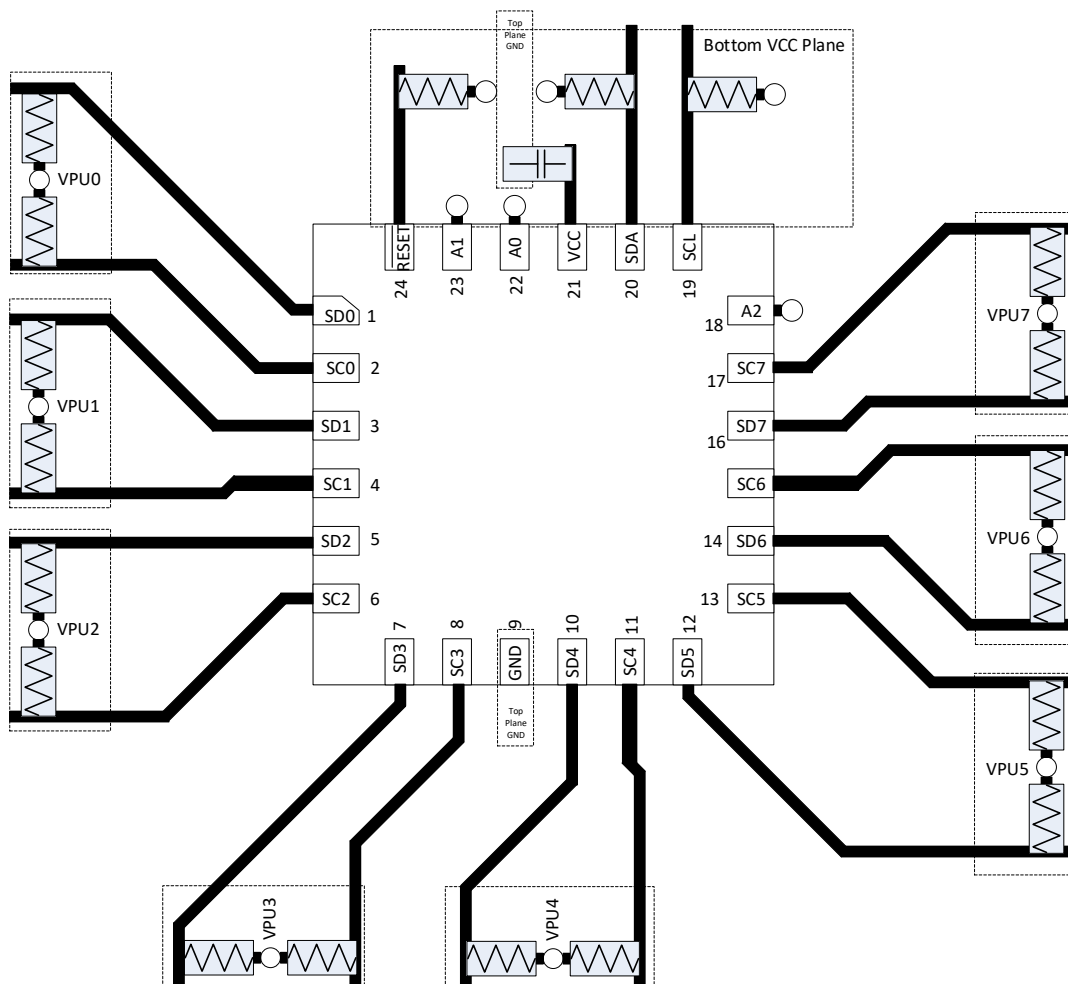


图 9-1. Layout Schematic

10 Device and Documentation Support

10.1 Documentation Support

10.1.1 Related Documentation

For related documentation see the following:

- [I2C Bus Pull-Up Resistor Calculation](#)
- [Maximum Clock Frequency of I2C Bus Using Repeaters](#)
- [Introduction to Logic](#)
- [Understanding the I2C Bus](#)
- [Choosing the Correct I2C Device for New Designs](#)
- [TCA9548AEVM User's Guide](#)

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10.5 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

10.6 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|--------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TCA9548ARGERQ1 | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | T9548A |
| TCA9548ARGERQ1.B | Active | Production | VQFN (RGE) 24 | 3000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | T9548A |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF TCA9548A-Q1 :

- Catalog : [TCA9548A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TCA9548ARGERQ1 | VQFN | RGE | 24 | 3000 | 330.0 | 12.4 | 4.25 | 4.25 | 1.15 | 8.0 | 12.0 | Q2 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TCA9548ARGERQ1 | VQFN | RGE | 24 | 3000 | 367.0 | 367.0 | 35.0 |

RGE 24

GENERIC PACKAGE VIEW

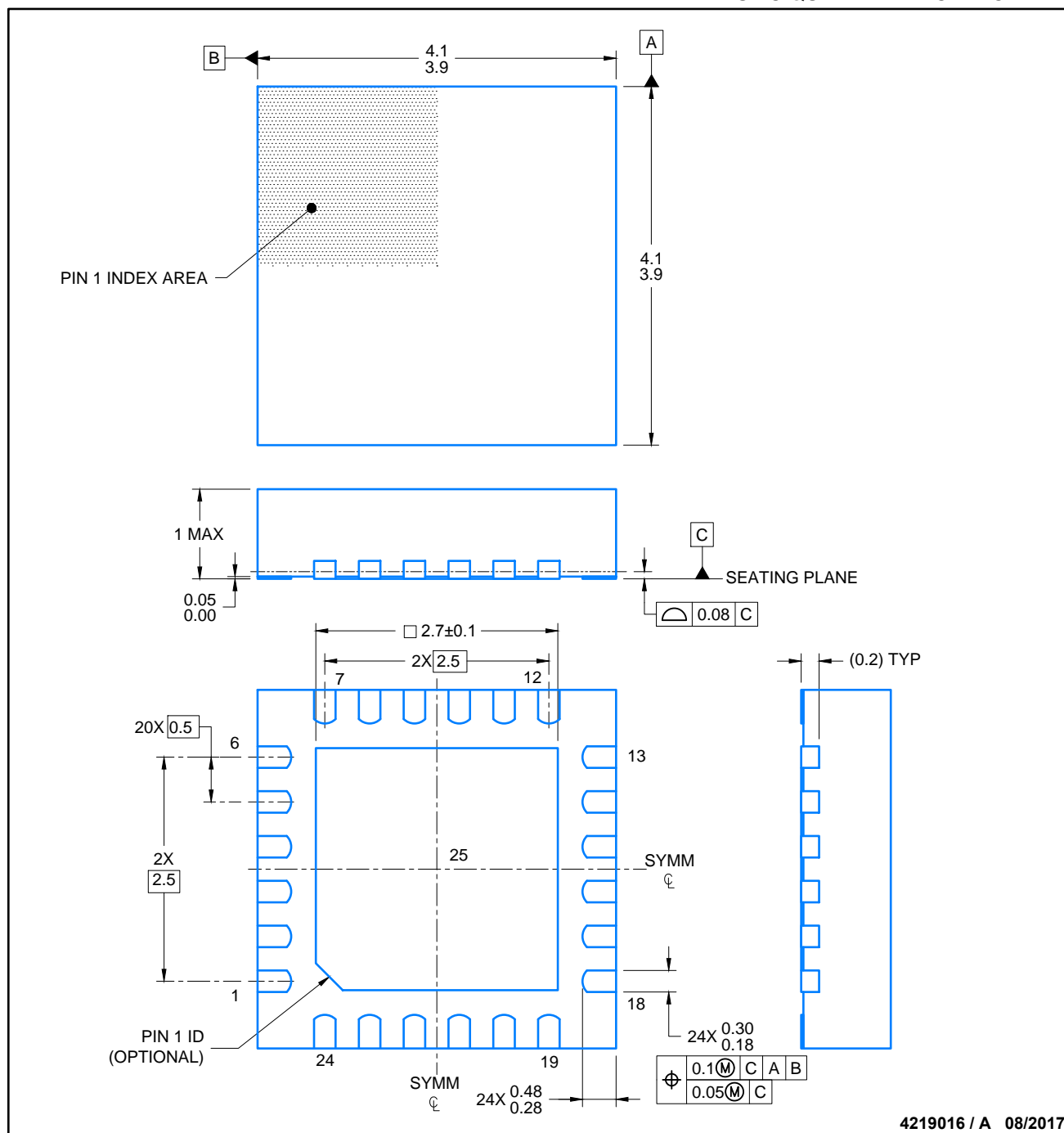
VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



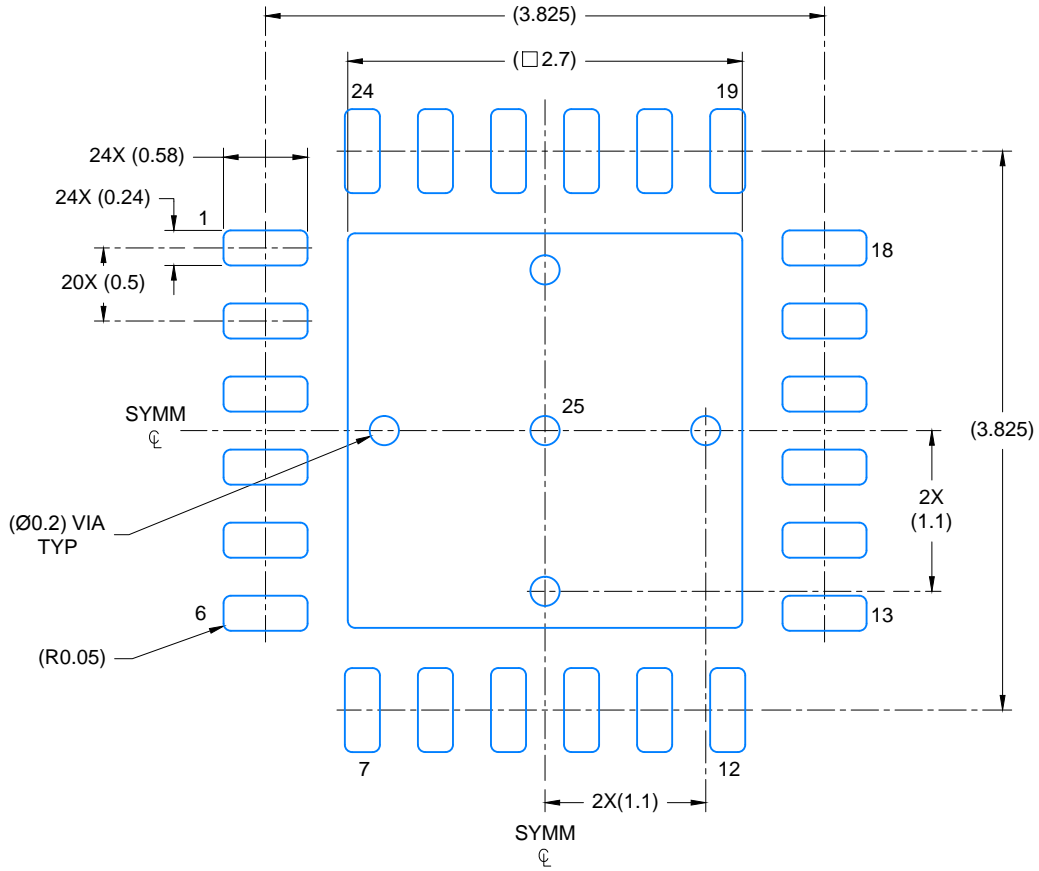
Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



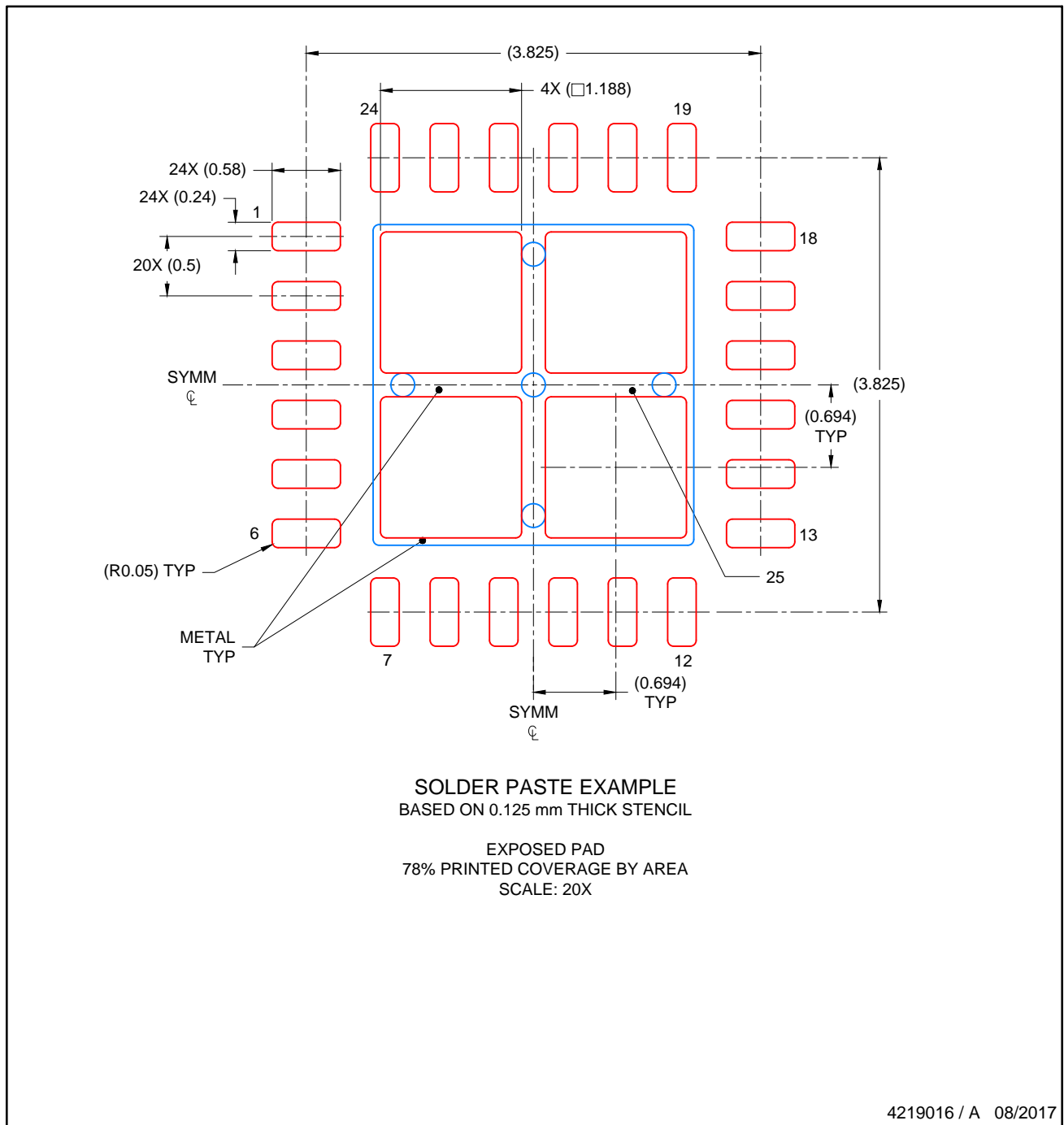
LAND PATTERN EXAMPLE
SCALE: 20X



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NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations..

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